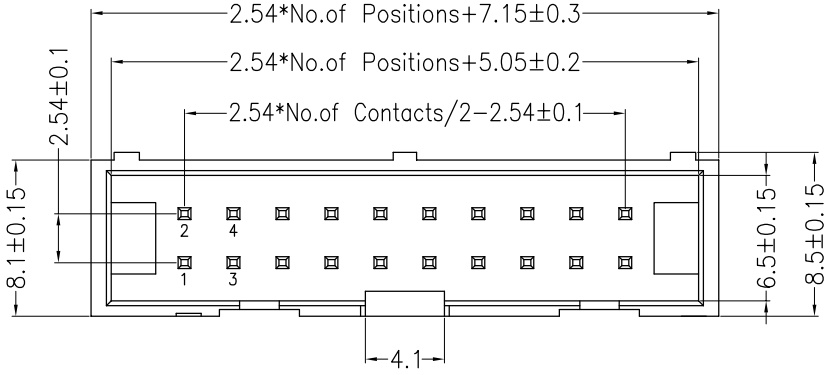
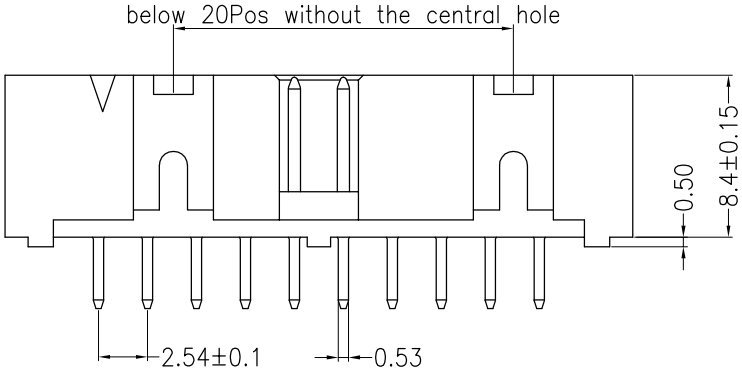
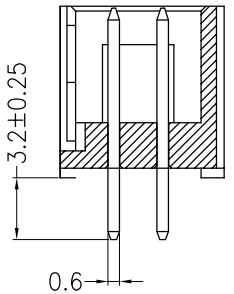
HSF RoHS FILE NO:E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA46
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



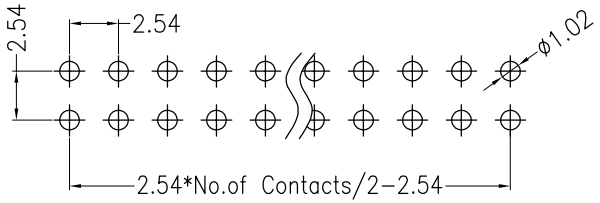




Ordering Information

3216 XX S XX D B K00 X 0X

- No.of Pins: 8−−64
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; S0:Gold Flash/Tin; SN:Tin
- Insulator Material Option: A=BK−PBT; B=BK−PA66; C=BK−PA6T; D=BK−PA46; E=BK−PA9T; F=BK−LCP
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A	2016.08.23	NEW DRAWING	

OPERATION		DRAW	Liu Miao	16.08.23	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3216XXSXXDBK00X0X
TITLE:	2.54DC3−NPIN H8.4 180°